Regulatory USB High-Side Power Switch

FEATURES

- 150mΩ (6V input) High-Side MOSFET Switch
- 0.5A/1A Continuous Load Current of USB switch
- 170μA Typical On-State Supply Current of USB switch
- 0.75μA Typical Off-State Supply Current of USB switch
- Fault Flag with 8ms filter eliminates false assertions
- Under Voltage Lockout Ensures that Switch is off at Start Up
- USB Switch Output can be Forced Higher than USB Switch Input (Off-State)
- Open-Drain Fault Flag
- Slow Turn ON and Fast Turn OFF
- Control Active-High or Active-Low
- Constant Current Limit / Short Circuit Protection
- Fast Short Circuit Protection Response
- Thermal Shutdown Protection (latching)
- Available in SOP-8 Exposed Pad Package

APPLICATIONS

- USB Power Management.
- Hot Plug-In Power Supplies.
- Battery-Charger Circuit.

DESCRIPTION

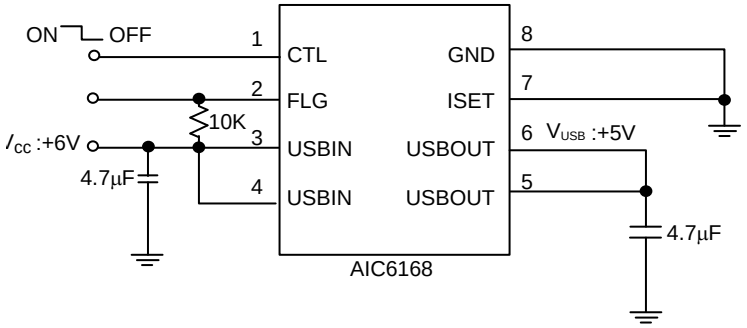
The AIC6168 is a power switch IC integrated a low dropout linear regulator for bus-powered Universal Serial Bus (USB) applications.

The high-side switch of USB power switch is MOSFET with 150mΩ $R_{DS(ON)}$, which meets USB voltage drop requirements for maximum transmission wire length.

Multi-purpose open-drain fault flag output indicates over-current limiting, thermal shutdown, or under voltage lockout. The output current of USB power switch is typical limited to 0.72A / 1.45A (control by select pin).

Guaranteed minimum output rise time limits inrush current during hot plug-in as well as minimizing EMI and prevents the voltage at upstream port from dropping excessively.

TYPICAL APPLICATION CIRCUIT



ORDERING INFORMATION

AIC6168XXXX XX

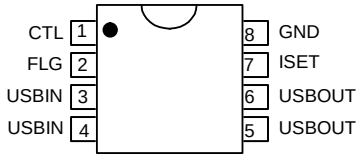
- PACKING TYPE
  TR: TAPE & REEL
  TB: TUBE
- PACKAGING TYPE
  R8: SOP-8 Exposed Pad
- G: Green Package
- CONTROL POLARITY
  L: Active Low
  H: Active High

Example: AIC6168LGR8TR

→ Active Low Version, in SOP-8 Exposed Pad Green Package and Taping & Reel Packing Type

PIN CONFIGURATION

SOP-8 Exposed Pad
TOP VIEW



Note:
The exposed pad should be connected with GND pin.

ABSOLUTE MAXIMUM RATINGS

USB Power Switch Supply Voltage (V_{USBIN})		-0.3V ~7.0V
USB Power Switch Output Voltage (V_{USBOUT})		-0.3V ~7.0V
Fault Flag Voltage (V_{FLG})		-0.3V ~7.0V
Fault Flag Current (I_{FLG})		50mA
Control Input (V_{CTL}, V_{ISET})		-0.3V ~7.0V
Operating Temperature Range		-40°C~85°C
Junction Temperature		150°C
Storage Temperature Range		-65°C ~ 150°C
Lead Temperature (Soldering, 10sec)		260°C
Thermal Resistance Junction to Case	SOP-8 Exposed Pad*	15°C/W
Thermal Resistance Junction to Ambient (Assume no ambient airflow)	SOP-8 Exposed Pad*	60°C/W

Absolute Maximum Ratings are those values beyond which the life of a device may be impaired.

* The package is placed on a two layers PCB with 2 ounces copper and 2 square inch, connected by 8 vias.

ELECTRICAL CHARACTERISTICS

(C_{USBIN} = 4.7μF, C_{USBOUT} = 4.7μF, V_{USBIN}= 6V, T_A=25°C, unless otherwise specified.) (Note 1)

PARAMETERS	CONDITIONS	MIN.	TYP.	MAX.	UNIT
USB POWER SWITCH					
Supply Current	Control Active High, USB switch output OFF, USBOUT=Open Control Active Low, USB switch output OFF, USBOUT=Open		0.75	5	μA
	Control Active High, USB switch output ON, USBOUT=Open Control Active Low, USB switch output ON, USBOUT=Open		170	250	μA
Control Input Threshold	Control Active High, USB switch output ON Control Active Low, USB switch output OFF	2.4		V_{USBIN}	V
	Control Active High, USB switch output OFF Control Active Low, USB switch output ON	0		0.8	V
USB Input Voltage	V_{USBIN}	5.3		7	V
Control Input Current	V_{CTL} =V_{USBIN} or GND		0	100	nA
Control Input Capacitance			1		pF
Dropout Voltage	V_{USBOUT} = 5V, I_{USBOUT} = 0.5A		150	190	mV
Dropout Voltage	V_{USBOUT} = 5V, I_{USBOUT} = 1A		300	380	mV
Output Turn-On Rise Delay	R_L = 10Ω		2.2	3.2	mS
Output Turn-On Rise Time	R_L = 10Ω	2	3.8	7	mS
Output Turn-Off Delay	R_L = 10Ω		0.8	20	μS
Output Turn-Off Fall Time	R_L = 10Ω		0.7	20	μS
Output Leakage Current				10	μA
Current Limit Threshold	ISET > 2.4V	0.6	0.72	0.85	A
Current Limit Threshold	ISET < 0.8V	1.2	1.45	1.7	A
Over Current Flag Response Delay	Apply V_{OUT} = 0V until FLG low	3	8	12	mS
Error Flag Output Resistance	V_{USBIN} = 6V, I_L =10 mA		10	25	Ω
Error Flag Off Current	V_{FLG} = 5V		0.01	1	μA

■ ELECTRICAL CHARACTERISTICS (Continued)

PARAMETERS	CONDITIONS	MIN.	TYP.	MAX.	UNIT
USB POWER SWITCH					
Under Voltage Lockout Threshold	V_{USBIN} rising	2.2	2.6	3	V
Under Voltage Lockout Hysteresis			200		mV
Thermal Protection					
Thermal Shutdown Temperature (Note 2)			150		℃

Note 1: Specifications are production tested at T_A=25°C. Specifications over the -40°C to 85°C operating temperature range are assured by design, characterization and correlation with Statistical Quality Controls (SQC).

Note 2: When thermal shutdown, the IC performs the function of latching in OFF state. It can resume operation by turning off once (min. 1μS) and then turn on using the CTL pin (with Typ. 25℃ Thermal Shutdown Hysteresis), or by restoring power to the USBIN pin.

TYPICAL PERFORMANCE CHARACTERISTICS

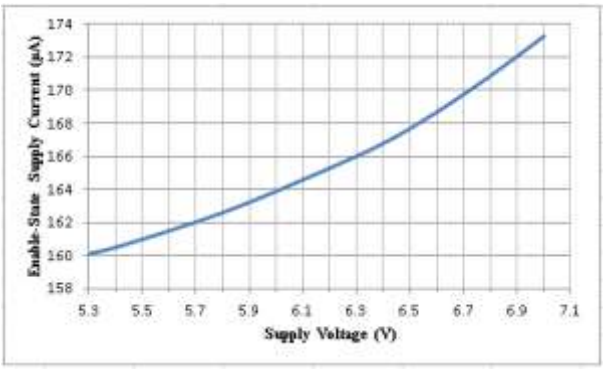


Fig. 1 Quiescent Current vs. Input Voltage

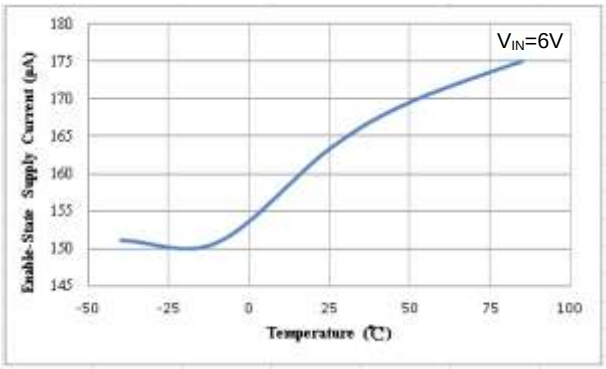


Fig. 2 Quiescent Current vs. Temperature

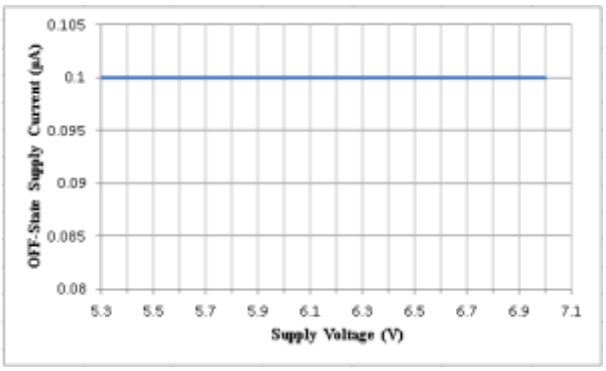


Fig. 3 Shut-down Current vs. Input Voltage

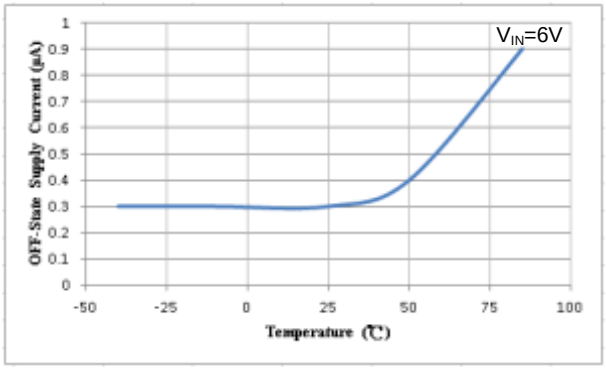


Fig. 4 Shut-down Current vs. Temperature

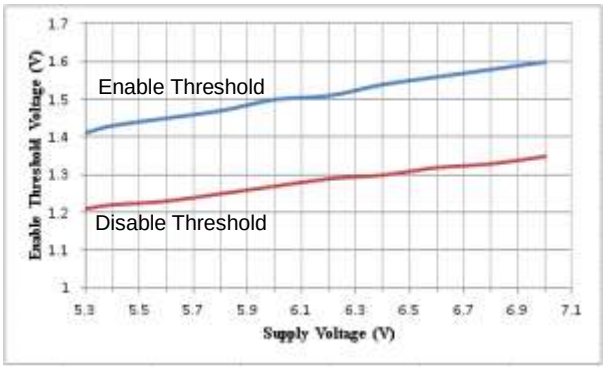


Fig. 5 Enable Threshold Voltage vs. Input Voltage

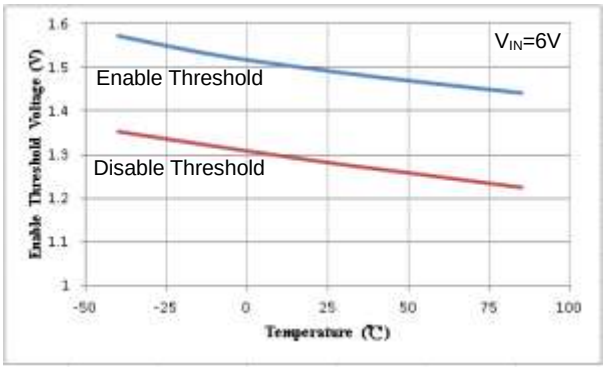


Fig. 6 Enable Threshold Voltage vs. Temperature

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

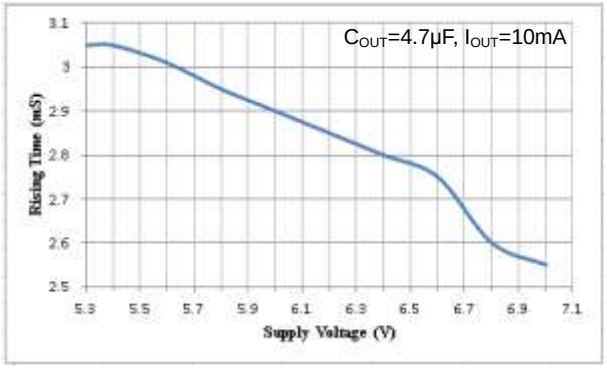


Fig. 7 Rising Time vs. Input Voltage

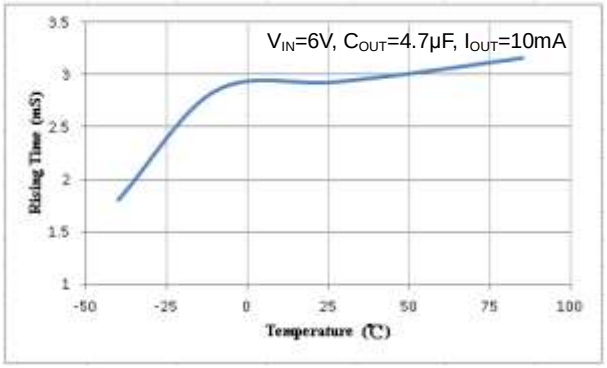


Fig. 8 Rising Time vs. Temperature

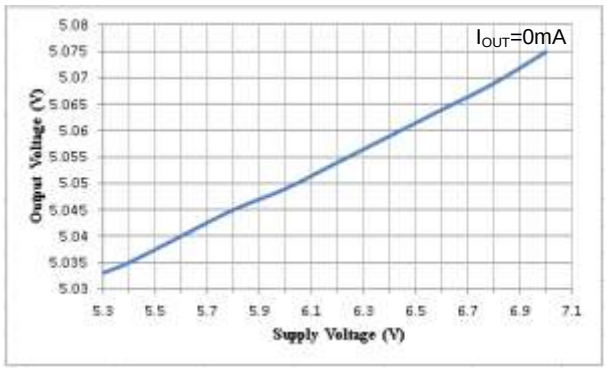


Fig. 9 Output Voltage vs. Input Voltage

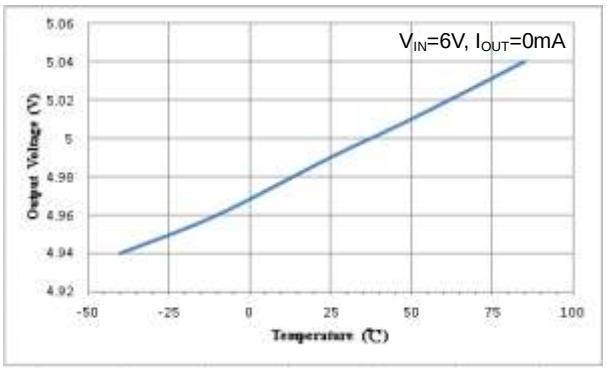


Fig. 10 Output Voltage vs. Temperature

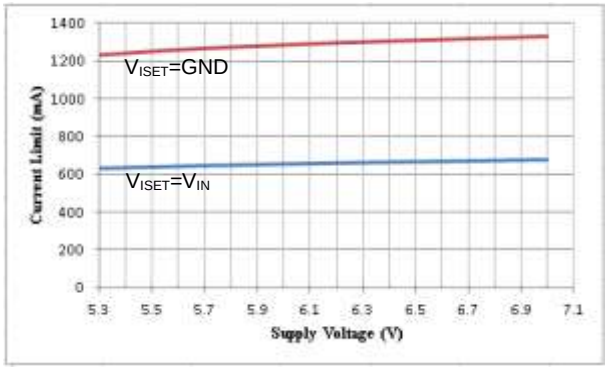


Fig. 11 Current Limit vs. Input Voltage

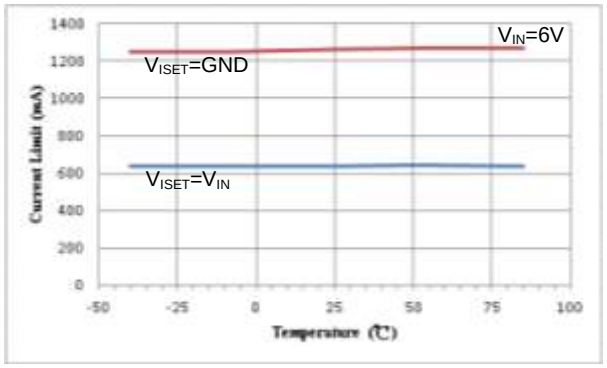


Fig. 12 Current Limit vs. Temperature

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

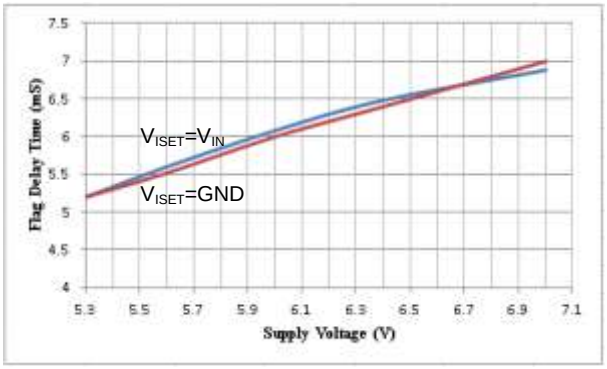


Fig. 13 Flag Delay Time vs. Input Voltage

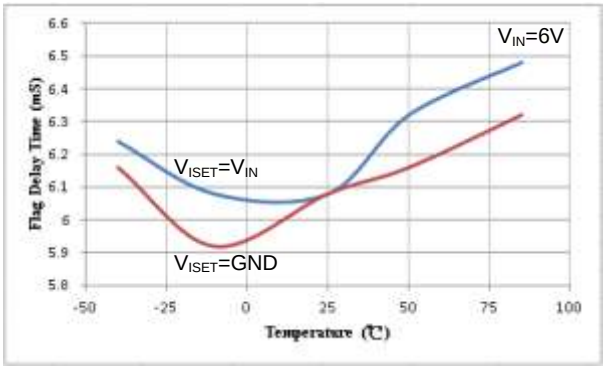


Fig. 14 Flag Delay Time vs. Temperature

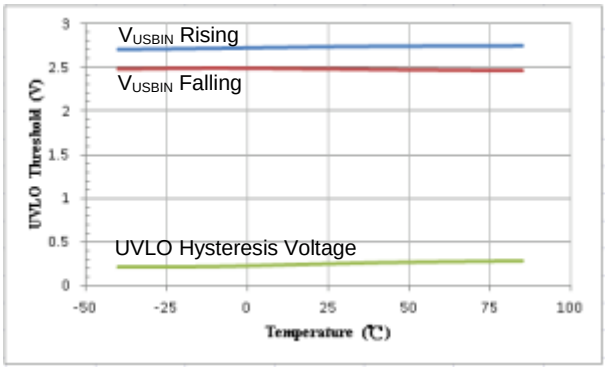


Fig. 15 UVLO Threshold vs. Temperature

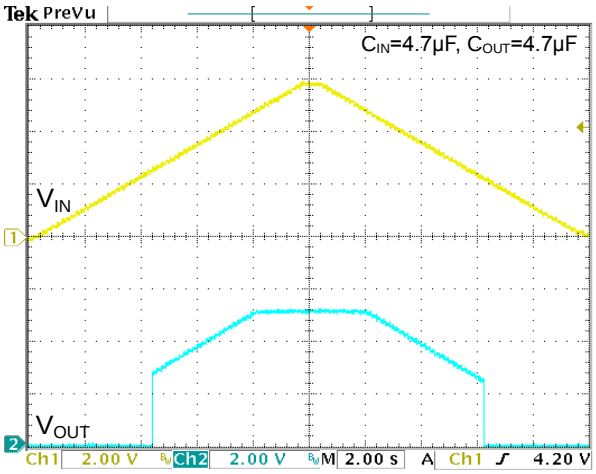


Fig. 16 UVLO Response (I_{OUT}=10mA)

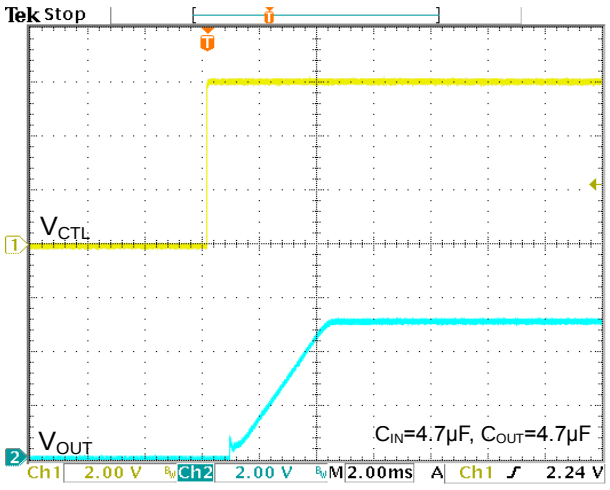


Fig. 17 Start Up Waveform (V_{IN}=6V, I_{OUT}=10mA)

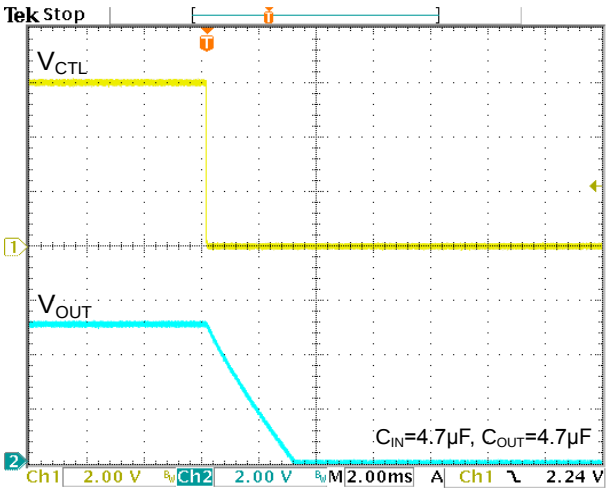


Fig. 18 Shutdown Waveform (V_{IN}=6V, I_{OUT}=10mA)

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

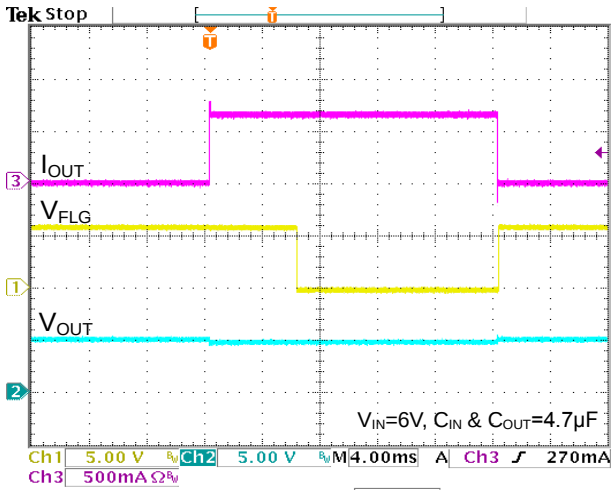


Fig. 19 Over Current Protection (V_{ISET}=V_{IN})

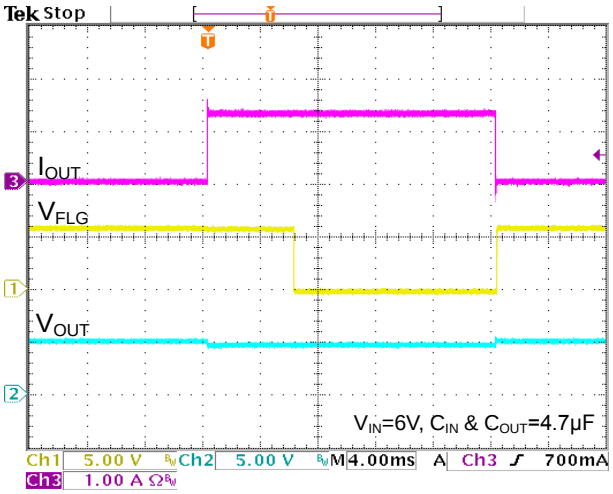


Fig. 20 Over Current Protection (V_{ISET}=GND)

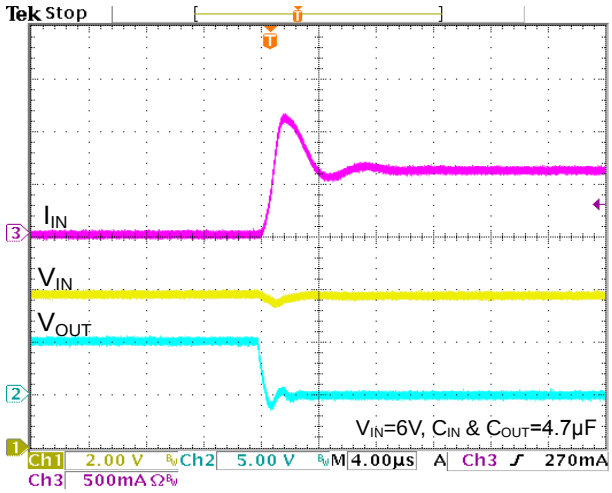


Fig. 21 Short Circuit Protection Response (V_{ISET}=V_{IN})

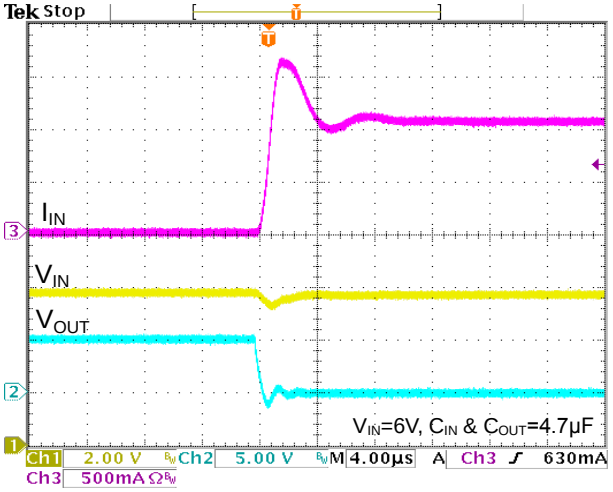
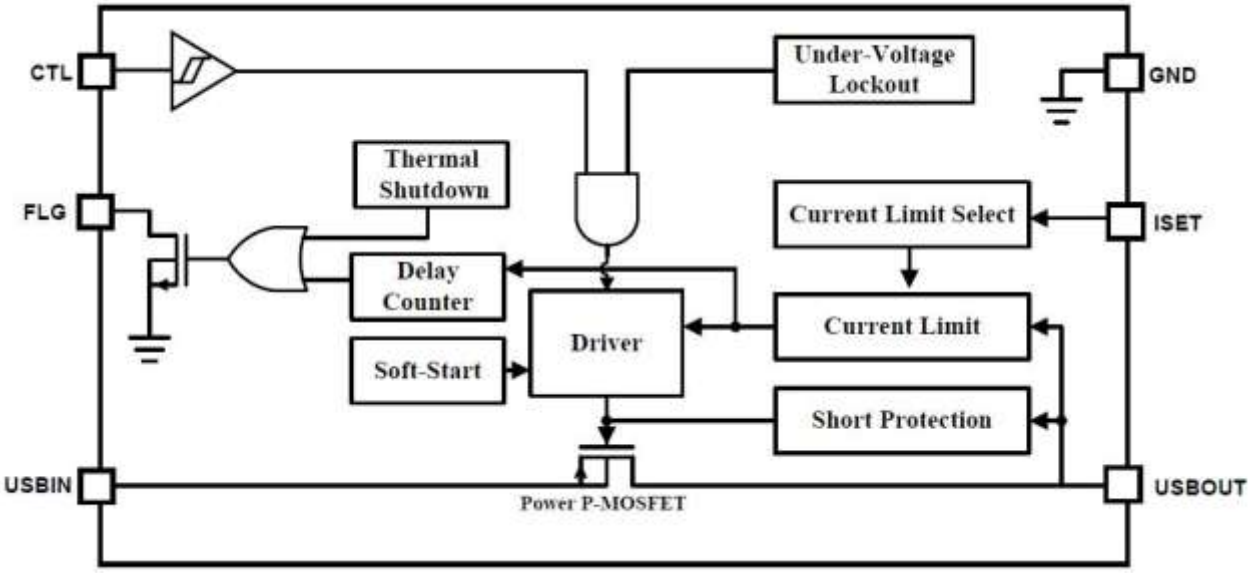


Fig. 22 Short Circuit Protection Response (V_{ISET}=GND)

BLOCK DIAGRAM



Functional Block Diagram of AIC6168

PIN DESCRIPTIONS

PIN 1: CTL - Controls the turn-on/turn-off of USB power switch with TTL as a control input. Active high for AIC6168H and active low for AIC6168L.

PIN 2: FLG - An active-low and open-drained fault flag output. FLG is an indicator for current limit when CTL is active. In normal mode operation (CTL is active), it also can indicate thermal shutdown.

PIN 3: USBIN - USB power supply input pin.

PIN 4: USBIN - USB power supply input pin.

PIN 5: USBOUT - USB switch output.

PIN 6: USBOUT - USB switch output.

PIN 7: ISET - Current limit setting pin. Connect to GND for 1.45A current limit. Connect to USBIN for 0.72A current limit

PIN 8: GND - Chip power ground.

APPLICATION INFORMATION

- **Error Flag**

An error Flag is an open-drained output of an N-channel MOSFET. FLG output is pulled low to signal the following fault conditions: output current limit and thermal shutdown. The Fault Flag response delay time is 8ms.

- **Current Limit**

The current limit threshold is preset internally. It protects the output MOSFET switches from damage resulting from undesirable short circuit conditions or excess inrush current, which is often encountered during hot plug-in. The error flag signals when any current limit conditions occur.

- **Thermal Shutdown**

When temperature of AIC6168 exceeds 150°C for any reasons, the thermal shutdown function turns the MOSFET switch off and signals the error flag. When thermal shutdown, the IC performs the function of latching in OFF state. It can resume operation by turning off once (min. 1μS) and then turn on using the CTL pin, or by restoring power to the USBIN pin.

- **Supply Filtering**

A 4.7μF bypass capacitor from USBIN to GND, located near the device, is strongly recommended to control supply transients. Without a bypass capacitor, an output short may cause sufficient ringing on the input (from supply lead inductance) to damage internal control circuitry.

- **Transient Requirements**

USB supports dynamic attachment (hot plug-in) of peripherals. A current surge is caused by the input capacitance of downstream device. Ferrite beads are recommended in series with all power and ground connector pins. Ferrite beads reduce EMI and limit the inrush current during hot-attachment by filtering high-frequency signals.

- **Output Capacitance**

Linear regulators require output capacitors to maintain stability and transient response. A 4.7μF output capacitor can satisfy most AIC6168 applications.

- **Dropout Voltage**

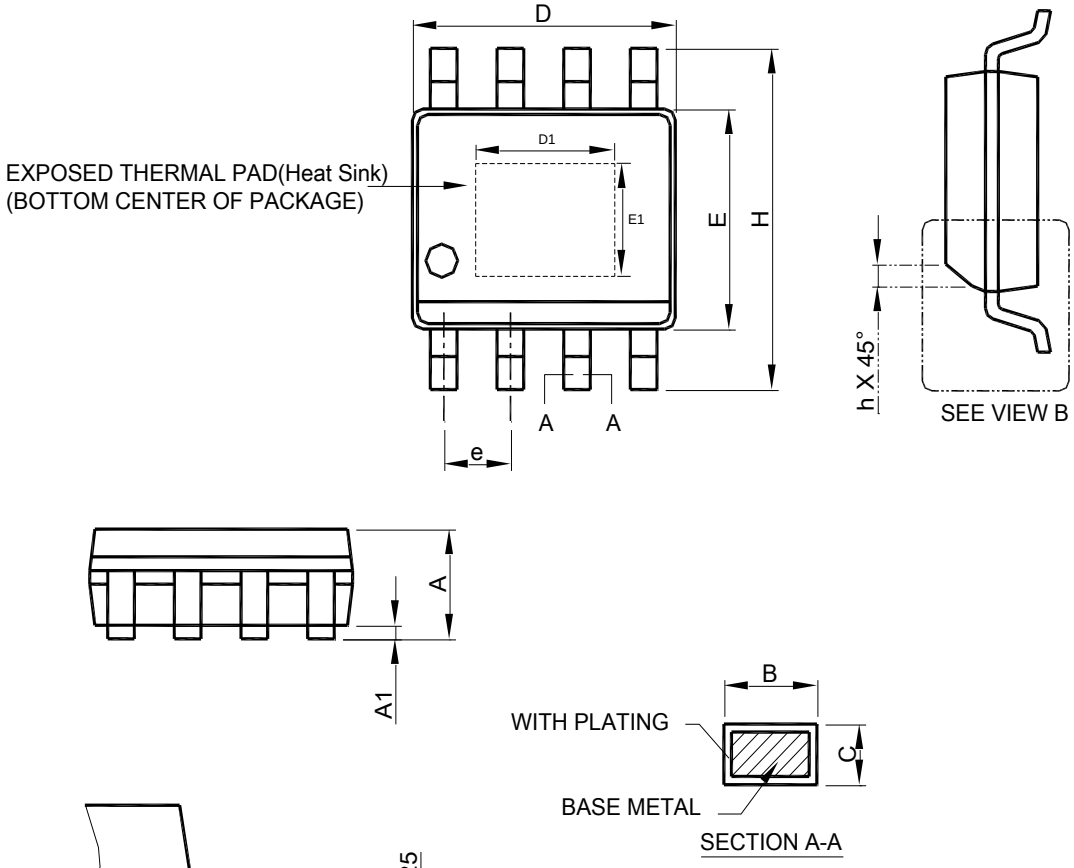
The dropout voltage is defined as the difference between input voltage and output voltage at which the output voltage drops 100mV. Below this value, the output voltage will fall while the input voltage reduces. It depends on the load current and junction temperature.

- **Printed Circuit Layout**

The power circuitry of USB printed circuit boards requires a customized layout to maximize thermal dissipation and to minimize voltage drop and EMI.

PHYSICAL DIMENSIONS

- **SOP-8 Exposed Pad**



SYMBOL	SOP-8 Exposed Pad	
	MILLIMETERS	
	MIN.	MAX.
A	1.35	1.75
A1	0.00	0.15
B	0.31	0.51
C	0.17	0.25
D	4.80	5.00
D1	1.50	3.50
E	3.80	4.00
E1	1.0	2.55
e	1.27 BSC	
H	5.80	6.20
h	0.25	0.50
L	0.40	1.27
θ	0°	8°

Note : 1. Refer to JEDEC MS-012E.
2. Dimension "D" does not include mold flash, protrusions or gate burrs. Mold flash, protrusion or gate burrs shall not exceed 6 mil per side .
3. Dimension "E" does not include inter-lead flash or protrusions.
4. Controlling dimension is millimeter, converted inch dimensions are not necessarily exact.

Note: